2024第一季法人說明會

May 8th, 2024





智慧財產權聲明

All rights, titles and interests contained in this information, texts, images, figures, tables or other files herein, including, but not limited to, its ownership and the intellectual property rights, are reserved to eMemory. This information may contain privileged and confidential information. Some contents in this information can be found in Logic Non-Volatile Memory (The NVM solutions from eMemory), published in 2014. Any and all information provided herein shall not be disclosed, copied, distributed, reproduced or used in whole or in part without prior written permission of eMemory Technology Inc.

eMemory, NeoBit, NeoFuse, NeoEE, NeoMTP, NeoROM, EcoBit and NeoPUF are all trademarks and/or service marks of eMemory in Taiwan and/or in other countries.



投資安全聲明

This presentation contains forward-looking statements, which are subject to risk factors associated with semiconductor and intellectual property business. It is believed that the expectations reflected in these statements are reasonable. But they may be affected by a variety of variables, many of which are beyond our control. These variables could cause actual results or trends to differ materially which include, but are not limited to: wafer price fluctuation, actual demand, rapid technology change, delays or failures of customers' tape-outs into wafer production, our ability to negotiate, monitor and enforce agreements for the determination and payment of royalties, any bug or fault in our technology which leads to significant damage to our technology and reputation, actual or potential litigation, semiconductor industry cycle and general economic conditions. Except as required by law, eMemory undertakes no obligation to update or revise any forward-looking statements, whether as a result of new information, future events, or otherwise.





- 1 Review of Operations
- 2 Future Outlook
 - Caliptra : Building a Silicon Root of
 - Trust in Datacenters and Every Chip
- 4 Q&A

3

5 Appendix

4







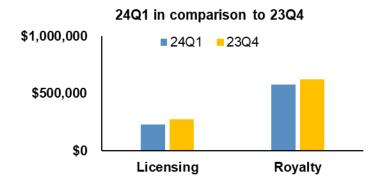


(thousands of NT dollars)

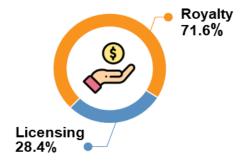
	Q1 2024	Q4 2023	Change (QoQ)	Q1 2023	Change (YoY)
Revenue	802,764	898,858	-10.7%	667,751	20.2%
Gross Margin	100%	100%	-	100%	-
Operating Expenses	382,143	359,330	6.3%	300,657	27.1%
-Operating Expenses exclude employee and director bonuses	279,605	279,173	0.2%	226,189	23.6%
-Employee and director bonuses	102,538	80,157	27.9%	74,468	37.7%
Operating Income	420,621	539,528	-22.0%	367,094	14.6%
Operating Margin	52.4%	60.0%	-7.6 ppts	55.0%	-2.6 ppts
*Net Income	430,577	403,753	6.6%	313,090	37.5%
Net Margin	52.7%	44.5%	8.2 ppts	46.1%	6.6 ppts
EPS (NT\$)	5.77	5.41	6.7%	4.20	37.4%
ROE	53.2%	53.1%	0.1 ppt	38.9%	14.3 ppts

*Net income attributable to Shareholders of the Company

第一季營收分析-授權金&權利金



Revenue Breakdown



ememory

Revenue

NT\$ Thousands	Q1 2024	Q4 2023	Change (QoQ)	Q1 2023	Change (YoY)
Licensing	228,329	273,927	-16.6%	143,049	59.6%
Royalty	574,435	624,931	-8.1%	524,702	9.5%
Total	802,764	898,858	-10.7%	667,751	20.2%

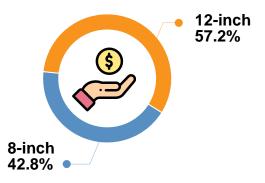
第一季營收分析 – 產品線

		Q1 2024							
		Total Revenue	•	Licensing Revenue			Royalty Revenue		
Technology	% of Q1 Revenue	Change (QoQ)	Change (YoY)	% of Q1 Licensing	Change (QoQ)	Change (YoY)	% of Q1 Royalty	Change (QoQ)	Change (YoY)
NeoBit	23.6%	-8.9%	1.0%	20.9%	-33.5%	70.0%	24.7%	4.0%	-11.1%
NeoFuse	67.0%	-8.7%	26.0%	52.6%	2.3%	69.3%	72.8%	-11.4%	17.4%
PUF-Based	2.3%	-38.9%	9.2%	8.0%	-39.0%	10.2%	0.0%	15.9%	-59.0%
МТР	7.1%	-20.3%	56.3%	18.5%	-22.8%	53.7%	2.5%	-12.2%	64.7%

Embedded Wisely, Embedded Widely

第一季營收分析 – 晶圓尺寸

Q1 Royalty Breakdown



- 8-inch wafers contributed 42.8% of royalty, up 4% sequentially but down 0.2% yearly.
- 12-inch wafers contributed 57.2% of royalty, down 15.4%
 QoQ but up 18.1% YoY.

Wefer Cine	Q1 2024					
Wafer Size	% of Q1	Change (QoQ)	Change (YoY)			
8-Inch	42.8%	4.0%	-0.2%			
12-Inch	57.2%	-15.4%	18.1%			







Licensing & Royalty:

- Licensing:
 - Due to strong demand from foundries and chip design customers for all of our technologies, the growth momentum of licensing revenue will continue to increase.
- Royalties:
 - Our royalty will grow, driven by 1500 new tape-outs from the past three years in the pipeline entering mass production (i.e. 6nm DTV, 7nm ADAS, 12 nm SSD and ISP, as well as 22/28nm networking, switch, and smart image processor...)

ememo



New IP Technology & Business Development:

- Specialty processes (HV, HK, BCD, embedded flash, and emerging memory):
 - 1. NeoFuse is developing towards FinFET in HV process for OLED DDI applications.
 - 2. RRAM is expanding into more processes.
 - 3. NeoFlash continues progressing in specialty processes for Automotive PMIC and MCU-related products.
- Advanced processes:
 - 1. NeoFuse has successfully qualified for the N5 automotive process with customer design in.
 - 2. PUFrt collaboration with CPU vendors in 3nm is progressing successfully.

ememo



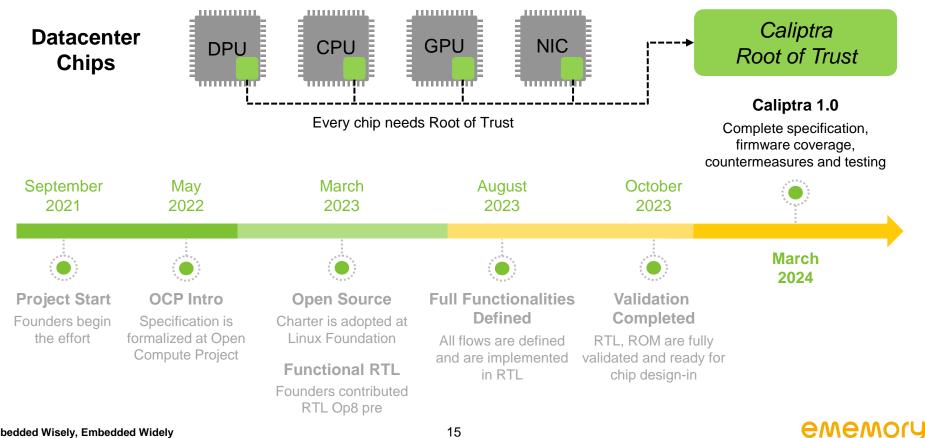
Business Collaboration Platforms:

- Non-volatile Memory (NVM) and PUF-based Technologies
 - We are expanding cooperation with all new foundries to license our technologies besides existing foundries.
- Security IPs:
 - We have completed the agreement with the largest CPU IP company to integrate our security solution into the CPU architecture.

Caliptra : Building a Silicon Root of Trust in Datacenters and Every Chip

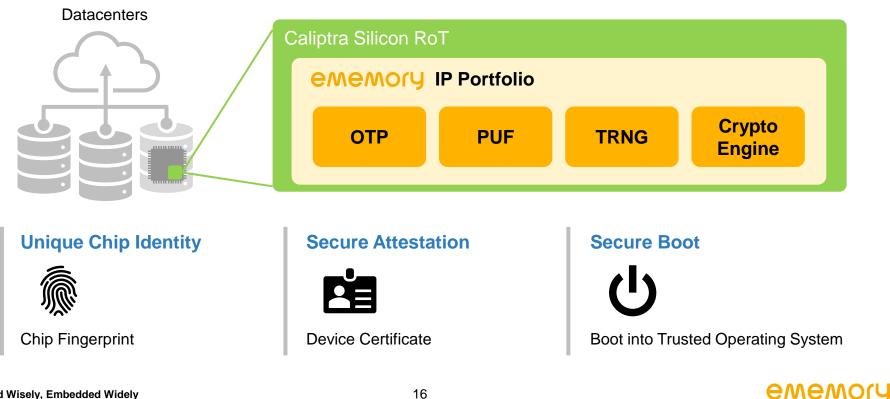


Why is **Caliptra** so Important?



What is the Important Role of **eMemory** in **Caliptra**?

eMemory's root of trust IP is ready to meet Caliptra's requirements.





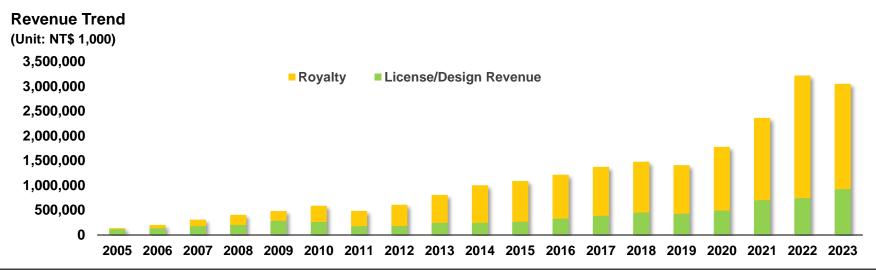


Appendix



Company Overview

eMemory is the global leader of embedded non-volatile memory IP



Founded In 2000

Based in Hsinchu, Taiwan. IPO in 2011. Over 58M wafers shipped.

1200 +Patents Issued

193 pending patents. 360 employees with 67% R&D personnel.

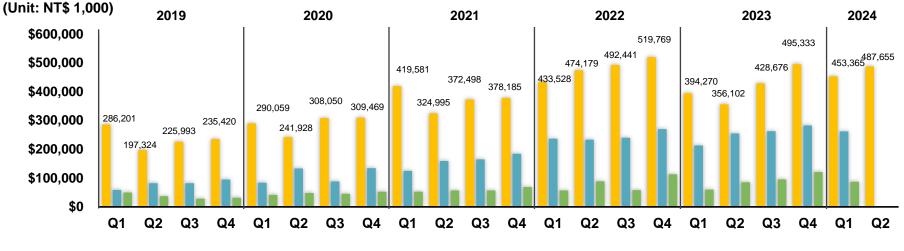
t IP Partner With TSMC

TSMC Best IP Partner Award since 2010.

ememory

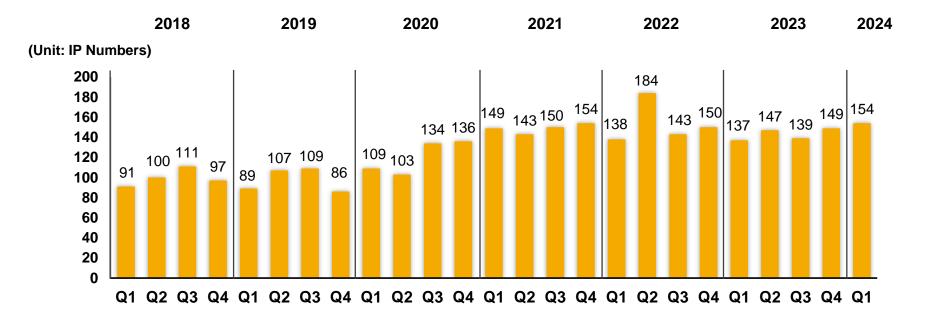
Quarterly Revenue Pattern

- 1st month: Receive License Fees of the month and Royalty from most foundries on previous quarter's wafer shipments.
- 2nd month: Receive License Fees of the month and Royalty from other foundries.
- 3rd month: License Fees Only.



First Month Second Month Third Month

Quarterly Number of New Tape-outs



ememo

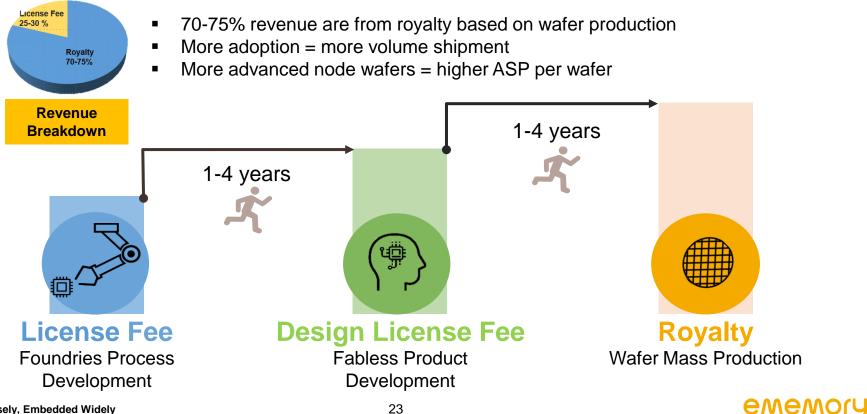
Worldwide Customers

Our IP solutions are adopted by leading foundries, IDMs and fabless worldwide



Business Model

Recurring royalty is the backbone of our business



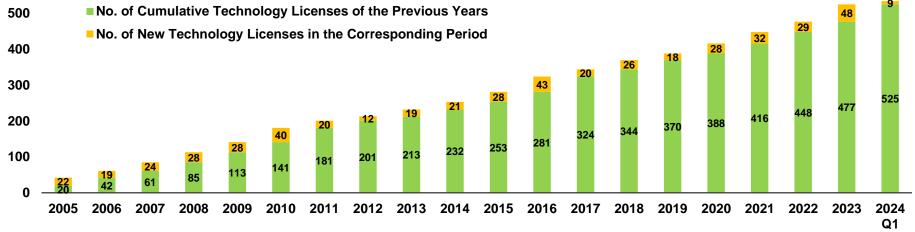
Technology Licenses

Number of Licenses

Year	2016	2017	2018	2019	2020	2021	2022	2023	2024 Q1
License	43	20	26	18	28	32	29	48	9

Note: Terms (including number of process platforms and licensing fees) for each technology license are set contractually. Payments are made according to set milestones, and there are no particular seasonal factors involved.

600



ememo

New Technology Under Development

- New technologies are being developed for 149 platforms by Q1 2024.
- 9 licensing contracts were signed.

Technology	3nm	4/5nm	6/7nm	12/16nm	22/28nm	40 nm	55/65nm	80/90nm	0.11~ 0.13um	0.15~ 0.18um	>0.25um
NeoBit	-	-	-	-	-	-	2	2	12	11	1
NeoFuse	3	-	1	7	18	6	13	8	5	4	-
PUF-Based	1	-	-	1	2	-	1	-	-	-	-
МТР	-	-	-	-	1	1	5	8	15	21	-

Note: As of March 31st, 2024

Technology Development

Developments by process nodes

12" Fabs	Production	Development	IP Туре	Process Type
3nm	0	4	OTP, PUF	FF, FFP
4/5nm	6	0	OTP, PUF	FF, FF-Auto
6/7nm	4	1	OTP, PUF	FF, FF+
12/16nm	9	8	OTP, PUF	FF, FF+, FFC. FFC+, LPP, DRAM, HV
22/28nm	50	21	OTP, PUF, MTP	LP/ULP/ULL, HPC/HPC+, HV-OLED, DRAM, SOI, ReRAM, MRAM, E-Flash, BCD, WoW
40nm	24	7	OTP, PUF, MTP	LP/ULP, E-Flash, HV-DDI/OLED, ReRAM, BCD+
55/65nm	51	21	OTP, PUF, MTP	LP/ULP, E-Flash, HV-DDI/OLED, DRAM, CIS, BCD, PM
80/90nm	28	15	OTP, MTP	HV-DDI/OLED, LP, Generic, BCD, CIS
0.11/0.13um	21	5	OTP, MTP	HV-DDI, BCD, Generic
0.15/0.18um	11	11	OTP, MTP	BCD, Generic
Total	204	93		

8" Fabs	Production	Development	IP Type	Process Type
80/90nm	9	3	ΟΤΡ	HV-DDI, LL, BCD
0.11/0.13um	81	27	OTP, MTP	HV/HV-MR, BCD, LP/LL, CIS, Green, Flash, SOI, Generic
0.152/0.16/0.18um	240	25	OTP, MTP	HV/HV-MR, BCD, LP/LL, CIS, Green, Generic
0.25um	42	1	OTP	BCD
0.3/0.35um	53	0	OTP, MTP	UHV, BCD
0.4/0.5um	11	0	OTP	UHV, BCD
Total	436	56		

Note: As of March 31st, 2024



Embedded Wisely, Embedded Widely

For more information, please visit:

eMemory Website: <u>https://www.ememory.com.tw/</u> PUFsecurity Website: <u>https://www.pufsecurity.com/</u>

